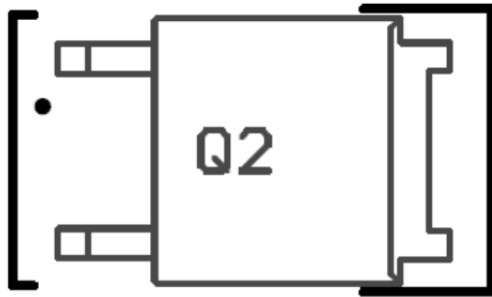


PCB VIEWED FROM TOP SIDE

UCC24630 DB
SVN:HPIP007
MADE IN U.S.
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PCB VIEWED FROM BOTTOM SIDE

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